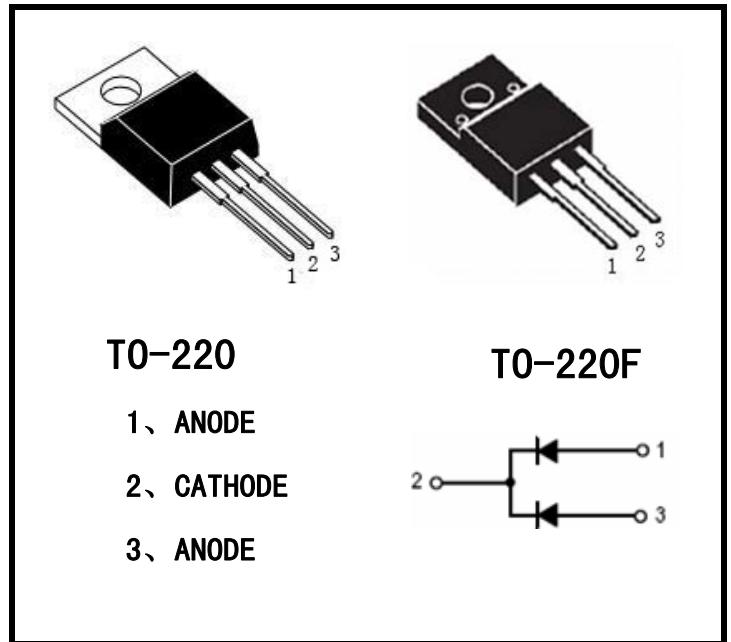




**FEATURES**

- \* Schottky Barrier Chip
- \* Guard Ring Die Construction for Transient Protection
- \* Low Power Loss, High Efficiency
- \* High Surge Capability
- \* High Current Capability and Low Forward Voltage Drop
- \* For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications

**PACKAGE**

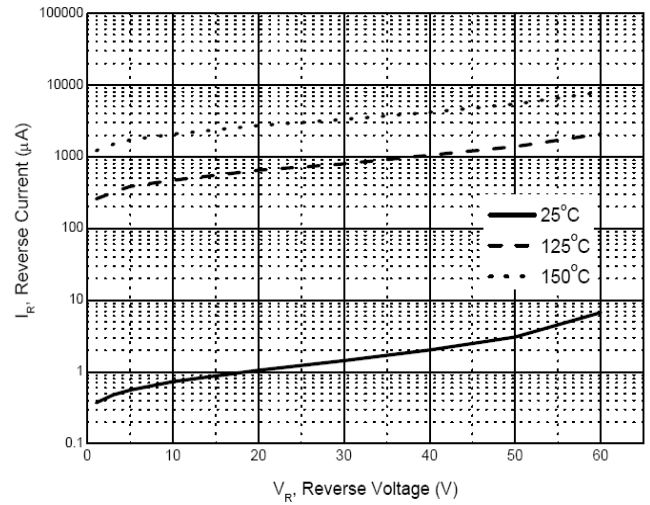
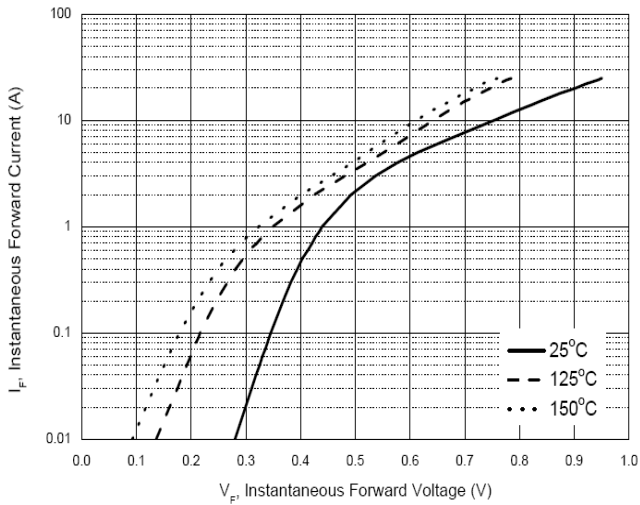


**ELECTRICAL CHARACTERISTICS (Tamb=25°C)**

Characteristic	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage	$V_{RRM}$	60	V	
Working Peak Reverse Voltage	$V_{RWM}$			
DC Blocking Voltage	$V_R$			
Average Rectifide Output Current	$I_{F(per\ leg)}$	5	A	
	$I_{F(Total)}$	10		
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60Hz)	$I_{FSM}$	150	A	
Maximum Instaneous Forward Voltage	$V_F$	@IF=5A, TC=25°C	0.65	V
		@IF=5A, TC=125°C	0.55	
Peak Reverse Current @Tc=25 °C at Rated DC Blocking Voltage @Tc=125°C	$I_R$	@Tc=25 °C	0.1	mA
		@Tc=125°C	6	
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to +150	°C	
Maximum Thermal Resistance	$\theta_{JC}$	T0-220	2	°C/W
		T0-220F	4	
	$\theta_{JA}$	T0-220	60	
		T0-220F	60	

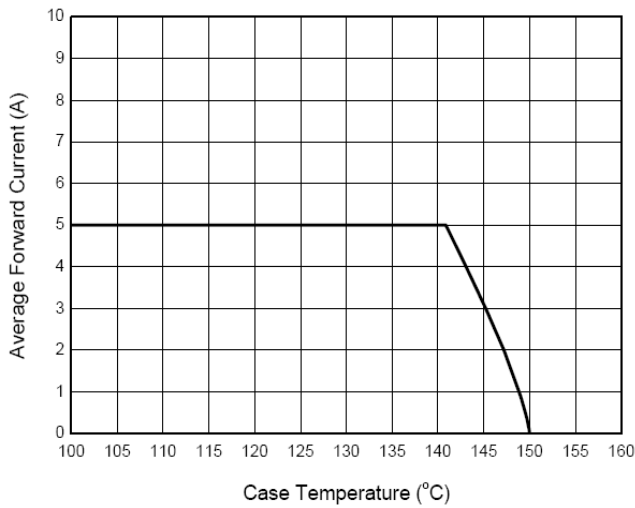


### Characteristics Curves



Typical Forward Voltage per Diode

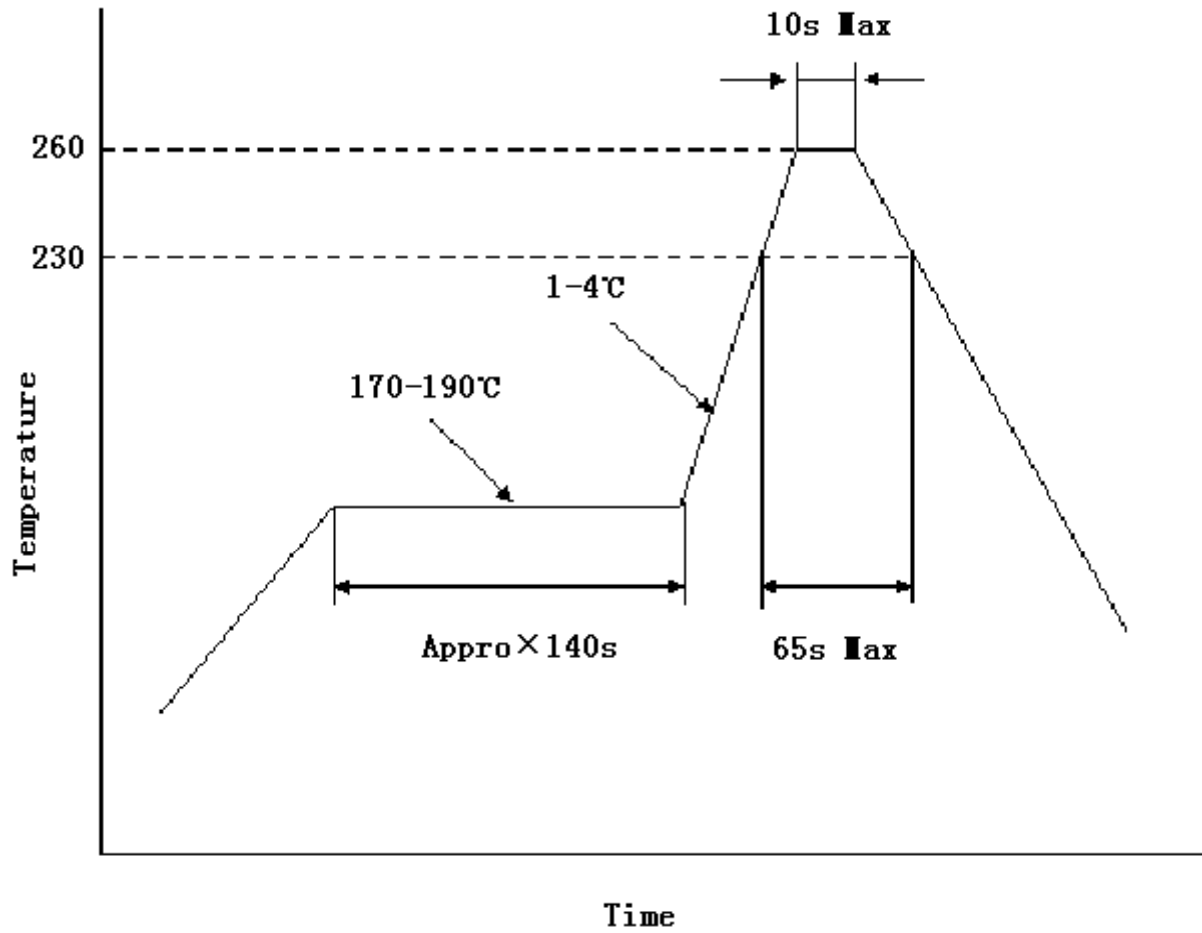
Typical Reverse Current per Diode



Average Forward Current vs. Case Temperature



### ■ Reflow Soldering Temperature Profile

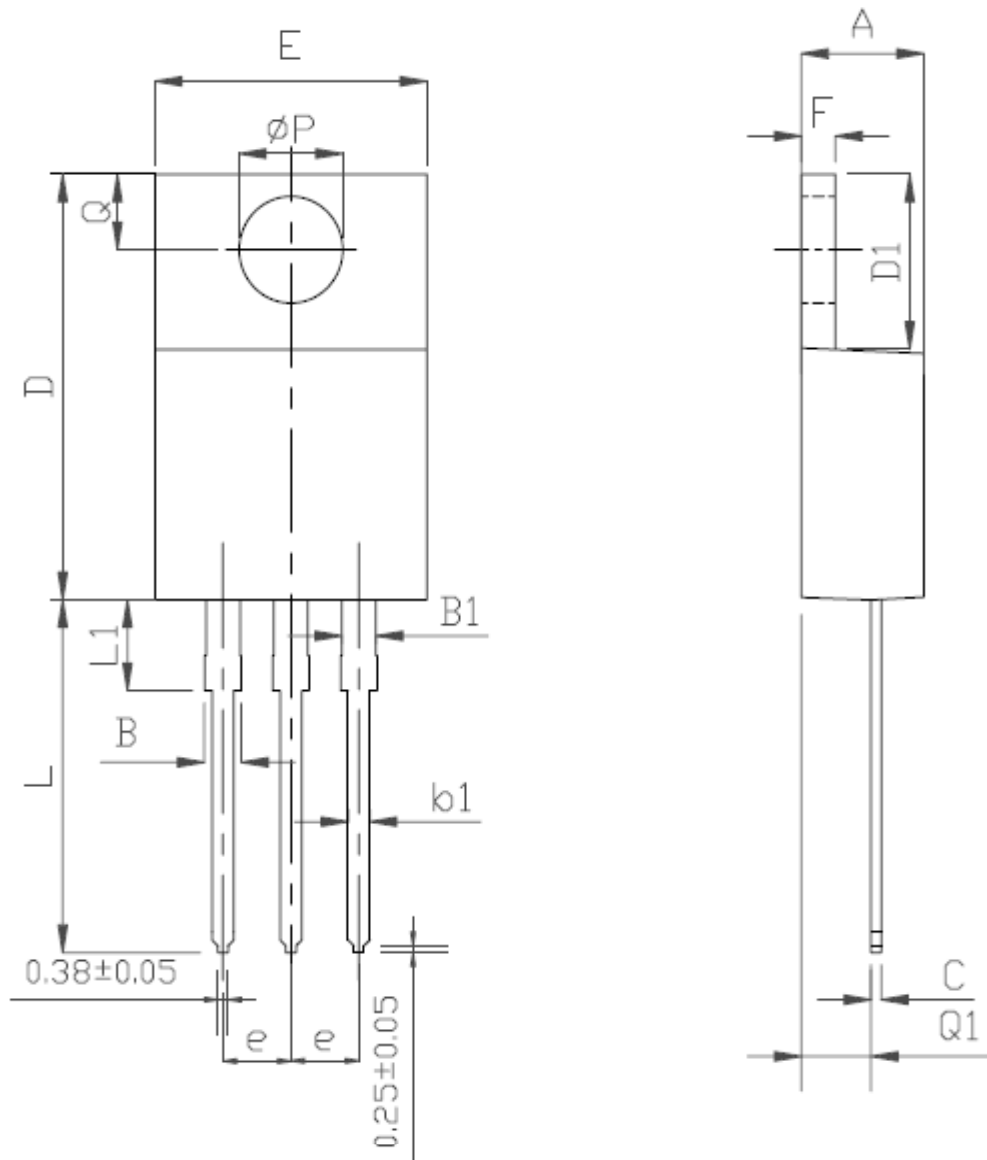




T0-220 MECHANICAL DATA

UNIT: mm

SYMBOL	MIN	NOM	MAX	SYMBOL	MIN	NOM	MAX
A	4		4.8	e	2.44	2.54	2.64
B	1.2		1.4	F	1.1		1.4
B1	1		1.4	L	12.5		14.5
b1	0.75		0.95	L1	3	3.5	4
c	0.4		0.55	ΦP	3.7	3.8	3.9
D	15		16.5	Q	2.5		3
D1	5.9		6.9	Q1	2		2.9
E	9.9		10.7				





TO-220F MECHANICAL DATA

UNIT: mm

SYMBOL	MIN	NOM	MAX	SYMBOL	MIN	NOM	MAX
A	4.5		4.9	E1	6.5	7	7.5
A1	2.3		2.9	e	2.44	2.54	2.64
b	0.65		0.9	L	12.5		14.3
b1	1.1		1.7	L1	9.45		10.05
b2	1.2		1.4	L2	15		16
c	0.35		0.65	L3	3.2		4.4
D	14.5		16.5	ΦP	3		3.3
D1	6.1		6.9	Q	2.5		2.9
E	9.6		10.3				

